Bridgelux WuXi R&D CO.,LTD

20V 4.5A N-Channel Enhancement Mode Power MOSFET

General Description

This Power MOSFET has been developed using advanced trench process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

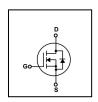
FEATURES

- RDSON \leq 27m Ω @Vgs=4.5V, Id=4A
- Excellent RDS(ON) and Low Gate Charge

Version: 1.1

· Lead free product is acquired

SYMBOL





SOT-23 top view

ASSEMBLY MESSAGE

Product Name	Marking	Package	Packaging
BXT270N02M 2302C		SOT-23	Reel

ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Parameter		Symbol	Rating	Unit	
		- Cy	SOT-23		
Drain-Source Voltage	Drain-Source Voltage			20	V
C C		tinuous ($T_C = 25^{\circ}C$)	l ₌	4.5	Α
Drain Current	Con	tinuous (T _C = 100°C)	ID	3.6	Α
Drain Current Pulsed (Note1)		I _{DM}	18	Α	
Gate-Source Voltage		V_{GSS}	±12	V	
Power Dissipation T _C =25°C		P _D	1.0	W	
Maximum Junction Temperature		TJ	150	°C	
Storage Temperature Range		T _{STG}	-55 to 150	°C	

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature



Bridgelux WuXi R&D CO.,LTD

THERMAL CHARACTERISTICS

Parameter	Symbol	Max.	Unit	
Parameter	Symbol	SOT-23	Onit	
Thermal Resistance, Junction-to- Ambient	Reja	125	°C/W	

ELECTRICAL CHARACTERISTICS (T_J=25°C,unless otherwise Noted)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V, ID=250µA				V	
Zero Gate Voltage Drain Current	IDSS	VDS=20V, VGS=0V			1	uA	
Gate-Body Leakage Current, Forward		VGS=12V			100	nA	
Gate-Body Leakage Current, Reverse	I _{GSS}	VGS=-12V			-100	nA	
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	VDS=VGS, ID=250μA	0.5	0.7	1.2	V	
Drain-Source On-State Resistance	D	VGS=4.5V, ID=4A		22	27	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	VGS=2.5V, ID=3A		29	44	mΩ	
DYNAMIC PARAMETERS							
Input Capacitance	Ciss	VDS=10V, VGS=0V, f=1.0MHz		610		pF	
Output Capacitance	Coss			110		pF	
Reverse Transfer Capacitance	Crss			58		pF	
SWITCHING PARAMETERS	SWITCHING PARAMETERS						
Turn-ON Delay Time	$t_{D(ON)}$			13		ns	
Turn-ON Rise Time	t_R	VDD=10V, ID=4.5A, VGS =		54		ns	
Turn-OFF Delay Time	t _{D(OFF)}	4.5V, RG=3Ω		20		ns	
Turn-OFF Fall-Time	t _F			18		ns	
Total Gate Charge(Note2)	Q_G	VDC 40V VCC 45V ID		5.8		nC	
Gate Source Charge	Q _{GS}	VDS =10V, VGS =4.5V, ID =4.5A		0.9		nC	
Gate Drain Charge	Q _{GD}	=4.5A		1		nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage	V _{SD}	IS=4.5A, VGS=0V			1.2	V	
Diode Continuous Forward Current	ls				4.5	Α	

Note: 2. Essentially independent of operating temperature



TYPICAL CHARACTERISTICS

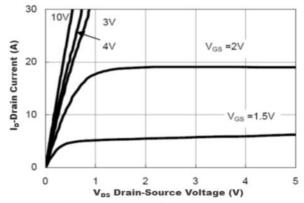


Figure 1. Output Characteristics

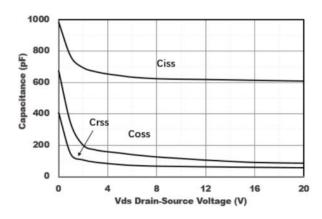


Figure 3. Capacitance Characteristics

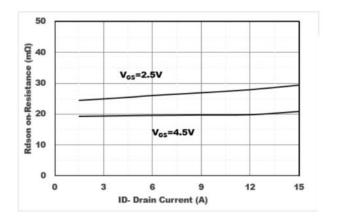


Figure 5. Drain-Source on Resistance

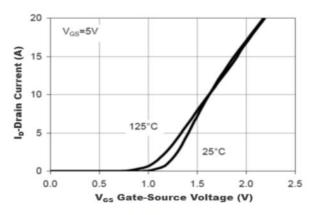


Figure 2. Transfer Characteristics

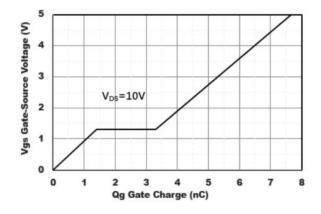


Figure 4. Gate Charge

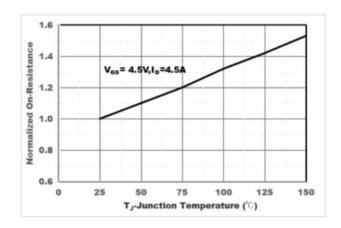


Figure 6. Drain-Source on Resistance

Version: 1.1

TYPICAL CHARACTERISTICS(Cont.)

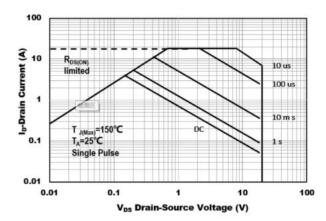
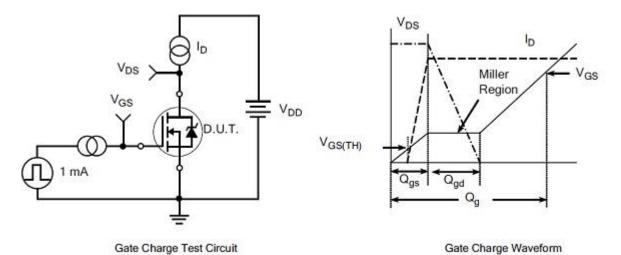
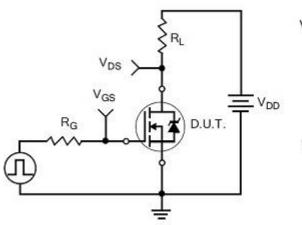


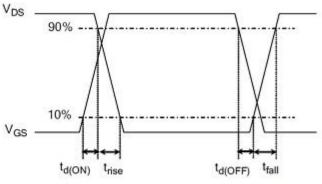
Figure 7. Safe Operation Area



TEST CIRCUITS AND WAVEFORMS





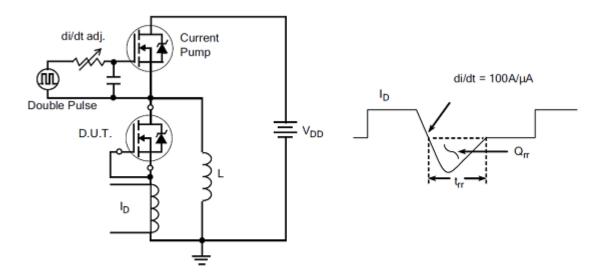


Resistive Switching Test Circuit

Resistive Switching Waveforms

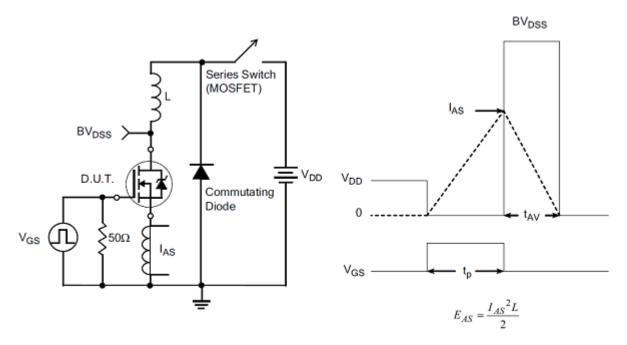


TEST CIRCUITS AND WAVEFORMS(Cont.)



Diode Reverse Recovery Test Circuit

Diode Reverse Recovery Waveform

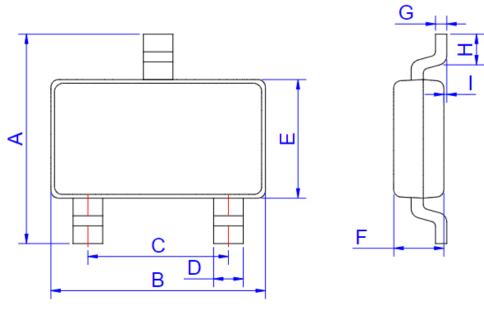


Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms



SOT-23 Package



SOT-23

	Dimensions				
Ref.	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
Α	2.250	2.550	0.089	0.100	
В	2.800	3.000	0.110	0.118	
С	1.800	2.000	0.071	0.079	
D	0.300	0.500	0.012	0.020	
Е	1.200	1.400	0.047	0.055	
F	0.900	1.150	0.035	0.045	
G		0.200		0.008	
Н	0.200		0.008		
I	0.000	0.150	0.000	0.006	

Revision history

Document revision history

Date	Revision	Changes
15-Oct-2020	1.0	First release
5-Mar-2021	1.1	Update the VGSS of page1

Bridgelux WuXi R&D CO.,LTD

Disclaimers:

Bridgelux WuXi has made reasonable commercial efforts to ensure that the information given in this data sheet is correct. However, it must clearly be understood that such information is for guidance only and does not constitute any representation or form part of any offer or contract.

For documents and material available from this data sheet, Bridgelux WuXi does not warrant or assume any legal liability or responsibility for the accuracy, completeness, or usefulness of any information, product, technology or process disclosed hereunder.

Bridgelux WuXi reserves the rights to at its own discretion to make any changes or improvements to this data sheet. Unless said data sheet is incorporated into the formal contract, any customer should not rely on the information as any specification or product parameters duly committed by Bridgelux WuXi. Customers are hereby advised to verify that the information contained herein is current and complete before the entering of any contract or acknowledgement of any purchase order. Accordingly, all products specified hereunder shall be sold subject to Bridgelux WuXi's terms and conditions supplied at the time of order acknowledgement. Except where agreed upon by contractual agreement, testing of all parameters of each product is not necessarily performed.

Bridgelux WuXi does not warrant or convey any license either expressed or implied under its patent rights, nor the rights of others. Reproduction of information contained herein shall be only permissible if such reproduction is without any modification or alteration. Reproduction of this information with any alteration is an unfair and deceptive business practice. Bridgelux WuXi is not responsible or liable for such altered documentation.

Resale of Bridgelux WuXi's products with statements different from or beyond the parameters stated by Bridgelux WuXi for that product or service voids all express or implied warrantees for the associated Bridgelux WuXi's product or service and is unfair and deceptive business practice. Bridgelux WuXi is not responsible or liable for any such statements.

Bridgelux WuXi's products are not authorized for use as critical components in life support devices or systems without the express written approval of Bridgelux WuXi. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Bridgelux manufacturer:

Other Similar products are found below:

614233C 648584F FDPF9N50NZ IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D
TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C IPP110N20N3GXK
IPS70R2K0CEAKMA1 DMN3404LQ-7 NTE6400 2SK2614(TE16L1,Q) DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W
FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2969
NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B
DMN1006UCA6-7 DMN16M9UCA6-7